

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Zhao HE	08/16/2013
RECEIVING PARTY DATA	
Name:	NANCHANG O-FILM TECH. CO., LTD.
Street Address:	O-film Technology Park, Huangjiahu West Road
Internal Address:	Changbei Economic and Technological Development Zone
City:	Nanchang, Jiangxi
State/Country:	CHINA
Postal Code:	330013
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14000194
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ATTORNEY DOCKET NUMBER:	ACIP 1017-1
NAME OF SUBMITTER:	James F. Hann
Signature:	/James F. Hann/
Date:	08/23/2013
Total Attachments: 2 source=00388173#page1.tif source=00388173#page2.tif	

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**SOLE TO CORPORATE
ASSIGNMENT**

WHEREAS, the undersigned,

Zhao HE
O-film Technology Park
Huangjiahu West Road
Changbei Economic and Technological Development Zone
Nanchang, Jiangxi 330013
CHINA

hereinafter termed "Inventor", has invented certain new and useful improvements in

CONDUCTIVE GLASS SUBSTRATE AND PREPARATION METHOD THEREOF

and

is filing a non-provisional application herewith, and

which application is a national filing of International Patent Application No.
PCT/CN2013/078891 filed 05 July 2013, (hereinafter termed "applications"); and

WHEREAS, NANCHANG O-FILM TECH. CO., LTD., a corporation of CHINA, having a place of business at O-film Technology Park, Huangjiahu West Road, Changbei Economic and Technological Development Zone, Nanchang, Jiangxi 330013 CHINA (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

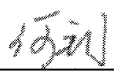
1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said applications and said invention; (b) in and to all rights to apply for foreign patents (including patent, utility model and industrial design) on said invention pursuant to US law, the International Convention for the Protection of Industrial Property or otherwise, including the right to claim priority from the application; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional application covering said invention; (d) for filing and prosecuting application for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any application therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall insure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, the inventor's respective heirs, legal representatives and assigns.

4. Said Inventor hereby warrants and represents that said inventor has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor has executed and delivered this instrument to said Assignee as of the date written below.



Zhao HE

Date: 2013-8-16